

Two-Stage Hysteretic LED Driver Controller

General Description

The RT8476A is a two-stage controller with dual gate drivers consist of a Boost converter (first stage) and a Buck converter (second stage). The advantage of the two-stage topology is highly compatible with ET (Electronic Transformer) in MR16 / AR111 lighting market field applications.

The first stage is a Boost converter for constant voltage output with inductor peak current over-current protection. The second stage is a Buck converter for constant output current by typical constant peak current regulation.

The RT8476A is equipped with dual output gate drivers for external power MOSFETs, suitable for higher power applications.

The RT8476A is available in the SOP-8 (Exposed pad) package.

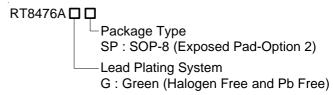
Applications

- MR16 Lighting
- Signage and Decorative LED Lighting
- · Architectural Lighting
- High Power LED Lighting
- Low Voltage Industrial Lighting
- Indicator and Emergency Lighting
- Automotive LED Lighting

Features

- Two-Stage Topology (Boost + Buck)
- Wide Input Voltage Range: 4.5V to 40V
- Adjustable Peak Input Current Control
- Adjustable Boost Output Voltage
- Independent Dual Stage Function
- Adjustable LED Current with ±5% LED Current Accuracy
- Input Under-Voltage Lockout Detection
- Thermal Shutdown Protection
- SOP-8 (Exposed Pad) Package
- RoHS Compliant and Halogen Free

Ordering Information

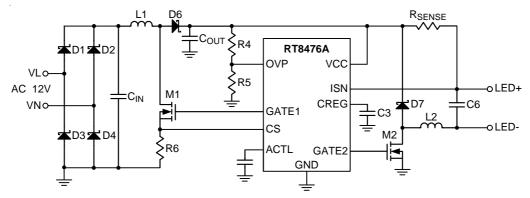


Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Simplified Application Circuit



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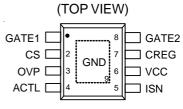


Marking Information

RT8476A GSPYMDNN RT8476AGSP: Product Number

YMDNN: Date Code

Pin Configurations

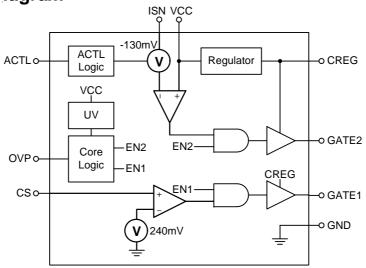


SOP-8 (Exposed Pad)

Functional Pin Description

Pin No.	Pin Name	Pin Function			
1	GATE1	Gate Driver Output for External MOSFET Switch in the First Stage.			
2	CS	Current Sense Input for External MOSFET Switch.			
3	OVP	Over-Voltage Protection Sense Input.			
4	ACTL	Analog/PWM Dimming Control Input.			
5	ISN	LED Current Sense Amplifier Negative Input.			
6	VCC	Supply Voltage Input. For good bypass, place a ceramic capacitor near the VCC pin.			
7	CREG	Internal Regulator Output. Place an $1\mu\text{F}$ capacitor between the CREG and GND pins.			
8	GATE2	Gate Driver Output for External MOSFET Switch in the Second Stage.			
9 (Exposed Pad)	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.			

Function Block Diagram



Operation

The VCC of the RT8476A is supplied from the first stage Boost output. The first stage is a constant output voltage Boost topology. The CS pin senses the peak inductor current for over-current protection. The peak inductor current level can be adjusted by the sense resistor between MOSFET Source and GND.

The second stage is a constant output current Buck topology. The current sense voltage threshold between the VCC and ISN pins is only 130mV to reduce power loss.



Absolute Maximum Ratings (Note 1)

Supply Input Voltage, VCC to GND	0.3V to 45V
• ACTL, CS, GATE1, GATE2, CREG, OVP to GND	0.3V to 6V
• VCC to ISN	1V to 3V
 Power Dissipation, P_D @ T_A = 25°C 	
SOP-8 (Exposed Pad)	- 3.44W
Package Thermal Resistance (Note 2)	
SOP-8 (Exposed Pad), θ_{JA}	- 29°C/W
SOP-8 (Exposed Pad), θ_{JC}	- 2°C/W
• Junction Temperature	- 150°C
• Lead Temperature (Soldering, 10 sec.)	- 260°C
Storage Temperature Range	- −65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	- 2kV
MM (Machine Model)	- 200V
Recommended Operating Conditions (Note 4)	

Recommended Operating Conditions (Note 4)

 Supply Input Voltage, 	VCC	4.5V to 40V
 Junction Temperature 	Range	-40°C to 125°C

• Ambient Temperature Range ----- --- -40°C to 85°C

Electrical Characteristics

(V_{CC} = 10V, No Load, C_{LOAD} = 1nF, T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit			
Supply Voltage									
CREG UVLO_ ON	V _{UVOL_ON}	CS/OVP = 0V	3.85	4.15	4.45	V			
CREG UVLO_ OFF	V _{UVOL_OFF}	CS/OVP = 0V		4.1		V			
Supply Current									
VCC Shutdown Current	I _{SHDN}	Before Start-Up, V _{CC} = 3.5V		10		μА			
VCC Quiescent Current	IQ	After Start-Up, V _{CC} = 5V, GATE1 and GATE2 Stand Still		1.5	1	mA			
Internal Reference Voltage	V _{CREG}			5	1	V			
Internal Reference Voltage		I _{CREG} = 20mA		4.9	1	V			
Current Sense Comparator	Current Sense Comparator								
CS Threshold Voltage	V _{CS}		215	240	265	mV			
CS Pin Leakage Current	Ics			1	1	μΑ			
ACTL Turn On Threshold	V _{ACTL_ON}			240	1	mV			
ACTL Turn Off Threshold	V _{ACTL_OFF}			120	1	mV			
ACTL Clamp Voltage				2.5		V			
ACTL Input Bias Current					1	μΑ			

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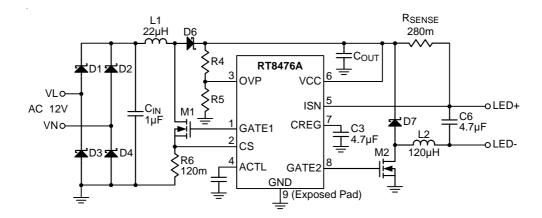


Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit	
OVP Threshold								
OVP	ligh-Level	V _{OVP_H}		1.71	1.9	2.09	V	
	ow-Level	V _{OVP_L}		1.44	1.6	1.76	V	
OVP Pin Leakage C	urrent	I _{OVP}			1		μΑ	
Gate Driver								
GATE1 Duty Off-Tim	е				1.5		μS	
UGATE1 Drive Sink		R _{UGATE1sk}	Sink = 50mA		2		Ω	
LGATE1 Drive Source		R _{LGATE1sr}	Source = -50mA		1.25		Ω	
GATE1 Default Pull Down Resistor					90		kΩ	
Buck Converter								
ISN Threshold		V _{ISN}		123.5	130	136.5	mV	
ISN Hysteresis		ΔV_{ISN}		10	15	20	%	
ISN Pin Leakage Current		I _{ISN}			1		μΑ	
UGATE2 Drive Sink		R _{UGATE2sk}	Sink = 50mA		2		Ω	
LGATE2 Drive Source		R _{LGATE2sr}	Source = -50mA		1.25		Ω	
GATE2 Default Pull Down Resistor					90		kΩ	
Temperature Protection								
Thermal Shutdown Threshold		T _{SD}		140	155	170	°C	
Thermal Shutdown Hysteresis		ΔT_{SD}			35		°C	

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25^{\circ}C$ on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

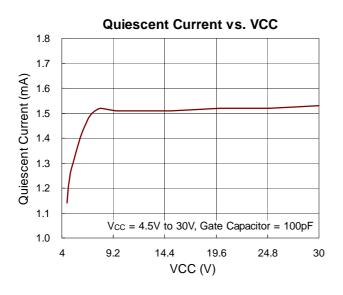


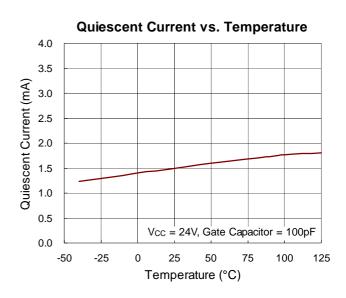
Typical Application Circuit

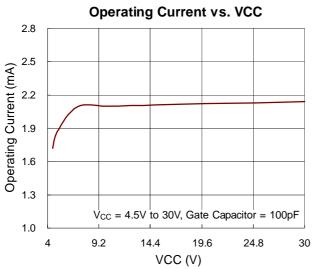


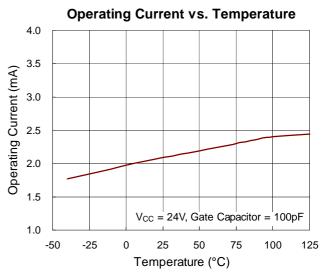


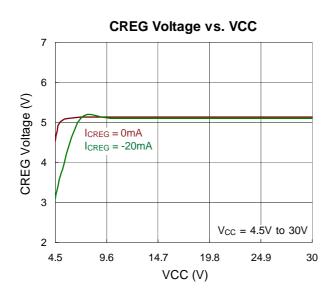
Typical Operating Characteristics

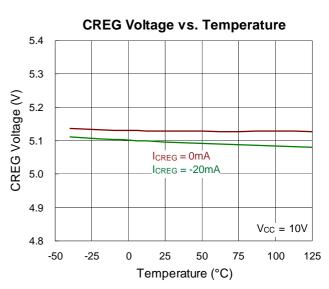






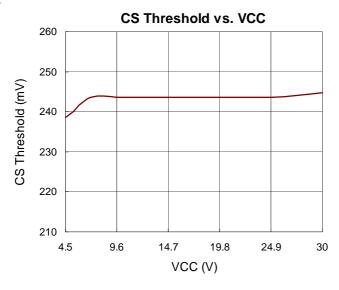


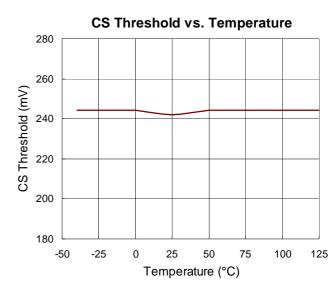


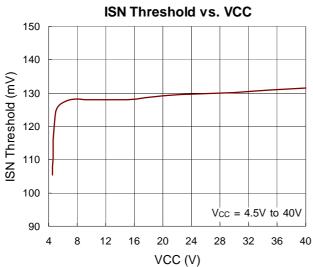


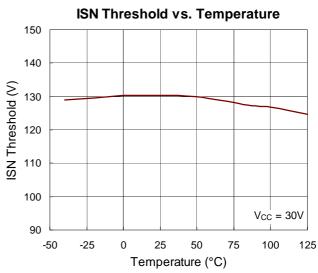
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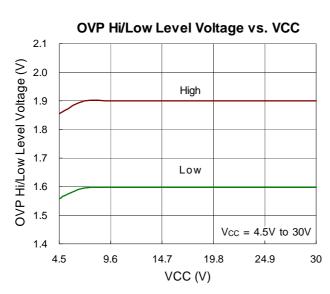


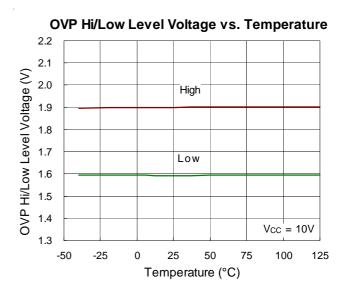






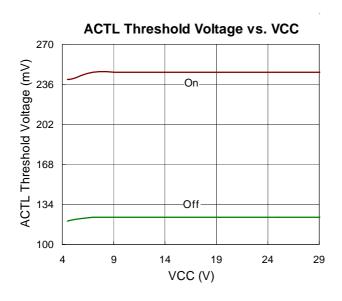


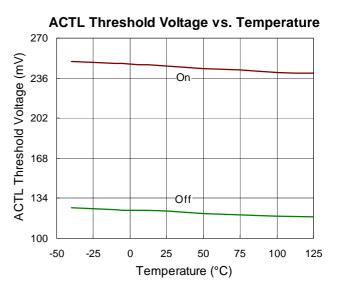


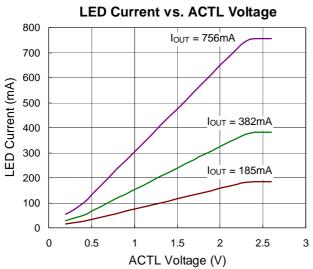


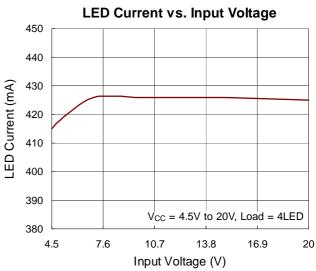
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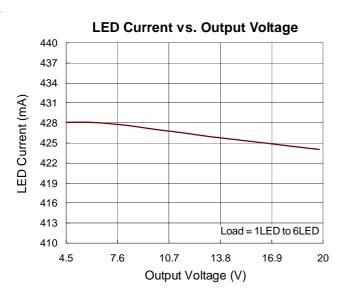


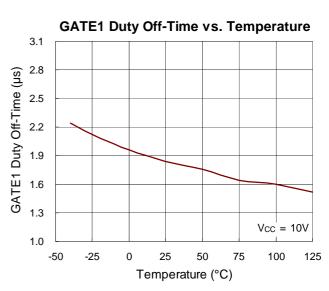






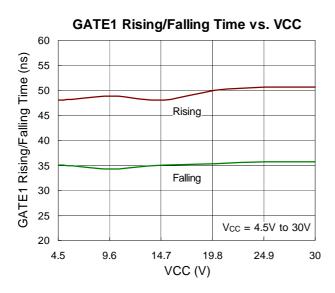


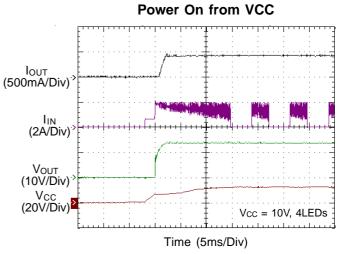


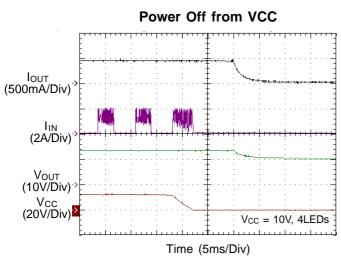


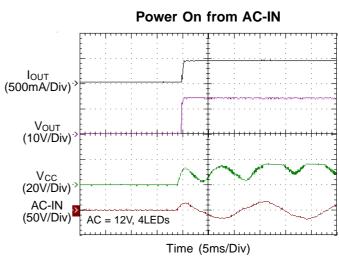
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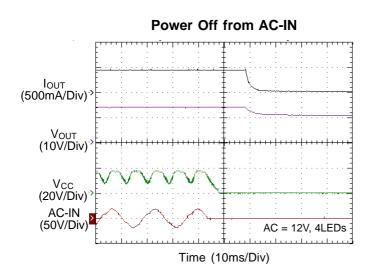












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Application Information

The RT8476A consists of a constant output current Buck controller and a fixed off-time controlled Boost controller. The Boost controller is based on a peak current, fixed offtime control architecture and is designed to operate up to 800kHz to use a very small inductor for space constrained applications. A high-side current sense resistor is used to set the output current of the Buck controller. A 1% sense resistor performs a ±5% LED current accuracy for the best performance.

Under-Voltage Lockout (UVLO)

The RT8476A includes an under-voltage lookout function with 100mV hysteresis. The internal MOSFET turns off when VCC falls below 4.2V (typ.).

CREG Regulator

The CREG pin requires a capacitor for stable operation and to store the charge for the large GATE switching currents. Choose a 10V rated low ESR, X7R or X5R, ceramic capacitor for best performance. A 4.7µF capacitor will be adequate for many applications. Place the capacitor close to the IC to minimize the trace length to the CREG pin and to the IC ground. An internal current limit on the CREG output protects the RT8476A from excessive onchip power dissipation.

The CREG pin has set the output to 4.3V (typ.) to protect the external FETs from excessive power dissipation caused by not being fully enhanced. If the CREG pin is used to drive extra circuits beside RT8476A, the extra loads should be limited to less than 10mA.

Gate Driver

There are two gate drivers, GATE1 and GATE2, in the RT8476A. The Gate driver consists of a CMOS buffer designed to drive the external power MOSFET. It features unbalanced source and sink capabilities to optimize switch on and off performance without additional external components. Whenever the IC supply voltage is lower than the under-voltage threshold, the Gate Driver is pulled low.

Analog Dimming Control

The ACTL terminal is driven by an external voltage, V_{ACTL}, to adjust the output current to an average value set by

R_{SENSE}. The voltage range for V_{ACTL} to adjust the output current is from 0.24V to 2.5V. If VACTL becomes larger than 2.5V, the output current value will just be determined by the external/resistor, R_{SENSE}.

$$I_{OUT avg} = \frac{0.13V}{R_{SENSE}} \times \frac{V_{ACTL} - 0.24}{2.5}$$

ACTL Control

The ACTL pin is the dimming function pin with the DC level proportional to the output LED current until ACTL clamp voltage that is the max output current (100%).

Average Output Current Setting

The output current that flows through the LED string is set by an external resistor, R_{SENSE}, which is connected between the VCC and ISN terminal. The relationship between output current, I_{OUT}, and R_{SENSE} is shown as below:

$$IOUT = \frac{130mV}{Rsense}$$

LED Current Ripple Reduction

Higher LED current ripple will shorten the LED life time and increase heat accumulation of LED. To reduce the LED current ripple, an output capacitor in parallel with the LED should be added. The typical value of output capacitor is $4.7\mu F$.

VCC Voltage Setting

The VCC voltage setting is equipped with an Over-Voltage Protection (OVP) function. When the voltage at the OVP pin exceeds threshold approximately 1.9V, the power switch is turned off. The power switch can be turned on again once the voltage at the OVP pin drops below 1.6V. For Boost applications, the output voltage can be set by the following equation:

$$V_{CC(MAX)} = 1.9 x (1 + R4 / R5)$$

R4 and R5 are the voltage divider resistors from VOUT to GND with the divider center node connected to the OVP pin. For MR16 LED lamp application, the minimum voltage of V_{CC} should maintain above 25V for stable operation.

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Step-Down Converter Inductor Selection

The RT8476A implemented a simple high efficiency, continuous mode inductive step-down converter. The inductance L2 in Buck converter is determined by the following factors: inductor ripple current, switching frequency, VOUT/VIN ratio, internal MOSFET, topology specifications, and component parameter. The inductance L2 is calculated according to the following equation:

$$\begin{split} L2 \geq & \left[V_{CC(MAX)} - V_{OUT} - V_{ISN} - \left(R_{DS2(ON)} \times I_{OUT} \right) \right] \times D \, / \, [f_{SW} \\ & \times \Delta I_{OUT}] \end{split}$$

where

fsw is switching frequency (Hz).

 $R_{DS2(ON)}$ is the low-side switch on-resistance of external MOSFET (M2). The typical value is 0.35Ω .

D is the duty cycle = V_{OUT} / V_{IN}

I_{OUT} is the required LED current (A)

 ΔI_{OUT} is the inductor peak-peak ripple current (internally set to 0.3 x $I_{OUT})$

V_{CC} is the supply input voltage (V)

V_{OUT} is the total LED forward voltage (V)

V_{ISN} is the voltage cross current sense resistor (V)

L2 is the inductance (H)

The selected inductor must have saturation current higher than the peak output LED current and continuous current rating above the required average output LED current. In general, the inductor saturation current should be 1.5 times the LED current. In order to minimize output current ripple, higher values of inductance are recommended at higher supply voltages. Because high values of inductance has high line resistance, it will cause lower efficiency.

Step-Up Converter Inductor Selection

The RT8476A uses a constant off-time control to provide high efficiency step-up converter. The resistor, R6, between the Source of the external N-MOSFET and GND should be selected to provide adequate switch maximum current to drive the application. The current limit threshold on the CS pin of the RT8476A is 240mV (typ.). When the CS pin voltage is higher than the 240mV reference, the comparator will disable the power section. The GATE1

will pull low after fixed delay time $1.5\mu s$ (typ.) and then turn on again after OVP operation is removed. This cycle repeats, keeping the output voltage within a small window. Following the constant off-time mechanism, the inductance L1 is calculated according to the following equation :

$$L1 > t_{OFF} \times (V_{CC(MAX)} - V_{IN(MIN)} + V_F) / I_{LIM}$$

where

t_{OFF} is Off-Time. The typical value is 1.5μs.

 I_{LIM} is the input current. The typical value is 2A for MR16 application.

V_{CC} is the supply input voltage (V)

V_{IN} is the input voltage after bridge diodes (V)

V_F is the forward voltage (V)

L1 is the inductance (H)

 $D = 1 - (V_{IN} / V_{OUT})$

 $f_{SW} = (1 - D) / t_{OFF}$

where

D is the operation duty

f_{SW} is the switching frequency of Boost controller.

Check the I_{LIM} setting satisfied the output LED current request by the following equation :

$$(I_{OUT} + \Delta I_{OUT}) < [2 \text{ x L1 x } I_{LIM} + t_{OFF} \text{ x } (V_{IN} - V_{OUT} - V_F)] \text{ x}$$

 $V_{IN} / [2 \text{ x L1 x } (V_{CC})]$

Diode Selection

To obtain better efficiency, the Schottky diode is recommended for its low reverse leakage current, low recovery time and low forward voltage. With its low power dissipation, the Schottky diode outperforms other silicon diodes and increases overall efficiency.

Input Capacitor selection

Input capacitor has to supply peak current to the inductor and flatten the current ripple on the input. The low ESR condition is required to avoid increasing power loss. The ceramic capacitor is recommended due to its excellent high frequency characteristic and low ESR, which are suitable for the RT8476A. For maximum stability over the entire operating temperature range, capacitors with better dielectric are suggested.

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Thermal Protection

A thermal protection feature is to protect the RT8476A from excessive heat damage. When the junction temperature exceeds 150°C, the thermal protection will turn off the LX terminal. When the junction temperature drops below 125°C, the RT8476A will turn on the LX terminal and return to normal operation.

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For SOP-8 (Exposed Pad) package, the thermal resistance, θ_{JA} , is 29°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at $T_A = 25^{\circ}C$ can be calculated by the following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (29^{\circ}C/W) = 3.44W \text{ for}$ SOP-8 (Exposed Pad) package

The maximum power dissipation depends on the operating ambient temperature for fixed T_{J(MAX)} and thermal resistance, θ_{JA} . The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

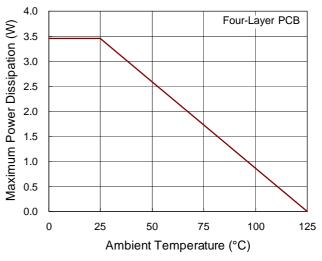


Figure 1. Derating Curve of Maximum Power Dissipation

Layout Consideration

PCB layout is very important to design power switching converter circuits. Some recommended layout guidelines are suggested as follows:

- ► The power components L1, D6, M1, C_{IN}, and C_{OUT} must be placed as close to each other as possible to reduce the ac current loop area. The power components L2, D7, and M2 must be placed as close to each other as possible to reduce the ac current loop area. The PCB trace between power components must be as short and wide as possible due to large current flow through these traces during operation.
- ▶ The capacitor C_{OUT}, C6 and external resistor, R_{SENSE}, must be placed as close as possible to the VCC and ISN pins of the device respectively.
- ▶ The GND should be connected to a strong ground plane.
- Keep the main current traces as short and wide as possible.

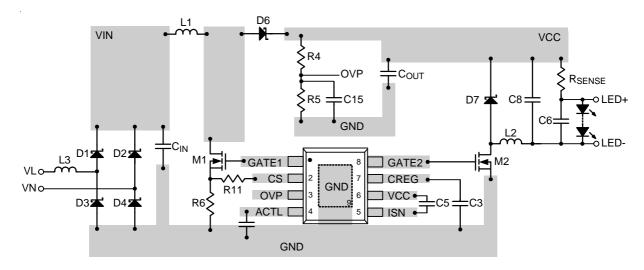
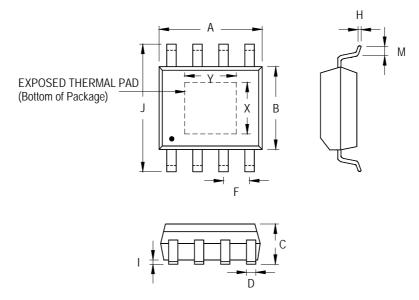


Figure 2. PCB Layout Guide



Outline Dimension



Symbol		Dimensions I	n Millimeters	Dimensions In Inches		
		Min	Max	Min	Max	
Α		4.801	5.004	0.189	0.197	
В		3.810	4.000	0.150	0.157	
С		1.346	1.753	0.053	0.069	
D		0.330	0.510	0.013	0.020	
F		1.194	1.346	0.047	0.053	
Н		0.170	0.254	0.007	0.010	
I		0.000	0.152	0.000	0.006	
J		5.791	6.200	0.228	0.244	
М		0.406	1.270	0.016	0.050	
Ontion 1	Х	2.000	2.300	0.079	0.091	
Option 1	Υ	2.000	2.300	0.079	0.091	
Ontion 2	Х	2.100	2.500	0.083	0.098	
Option 2	Υ	3.000	3.500	0.118	0.138	

8-Lead SOP (Exposed Pad) Plastic Package

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